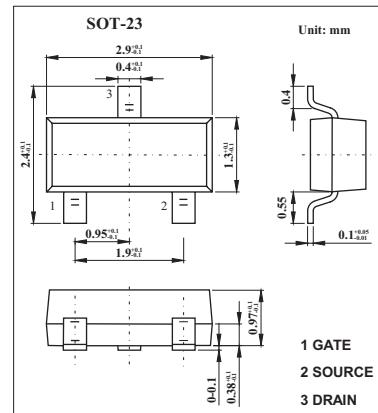


MOS Field Effect Transistor

2SJ209

■ Features

- Directly driven by I_{CS} having a 5V power supply.
- Not necessary to consider driving current because of its high input impedance.
- Possible to reduce the number of parts by omitting the biasresistor.



■ Absolute Maximum Ratings Ta = 25°C

Parameter	Symbol	Rating	Unit
Drain to source voltage V _{GS} =0	V _{DSS}	-100	V
Gate to source voltage V _{DS} =0	V _{GSS}	±16	V
Drain current (DC)	I _D	±100	mA
Drain current(pulse) *	I _D	±200	mA
Power dissipation	P _D	200	mW
Channel temperature	T _{ch}	150	°C
Storage temperature	T _{stg}	-55 to +150	°C

* PW ≤ 10 ms; d ≤ 50%.

■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Testconditons	Min	Typ	Max	Unit
Drain cut-off current	I _{DSS}	V _{DS} =-100V, V _{GS} =0			-10	μA
Gate leakage current	I _{GSS}	V _{GS} =±16V, V _{DS} =0			±10	μA
Gate cut-off voltage	V _{GS(off)}	V _{DS} =-5.0V, I _D =-1 μA	-1.5	-2.0	-2.5	V
Forward transfer admittance	Y _{fs}	V _{DS} =-5.0V, I _D =-10mA	15	22		ms
Drain to source on-state resistance	R _{DSS(on)}	V _{GS} =-4.0V, I _D =-10mA		60	100	Ω
		V _{GS} =-10V, I _D =-10mA		37	60	Ω
Input capacitance	C _{iss}	V _{DS} =-5.0V, V _{GS} =0, f=1MHZ		17		pF
Output capacitance	C _{oss}			9		pF
Reverse transfer capacitance	C _{rss}			1		pF
Turn-on delay time	t _{d(on)}	V _{GS(on)} =-4V, R _G =10 Ω, V _{DD} =-5V, I _D =-10mA R _L =500 Ω		45		ns
Rise time	t _r			75		ns
Turn-off delay time	t _{d(off)}			25		ns
Fall time	t _f			80		ns

■ Marking

Marking	H17
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